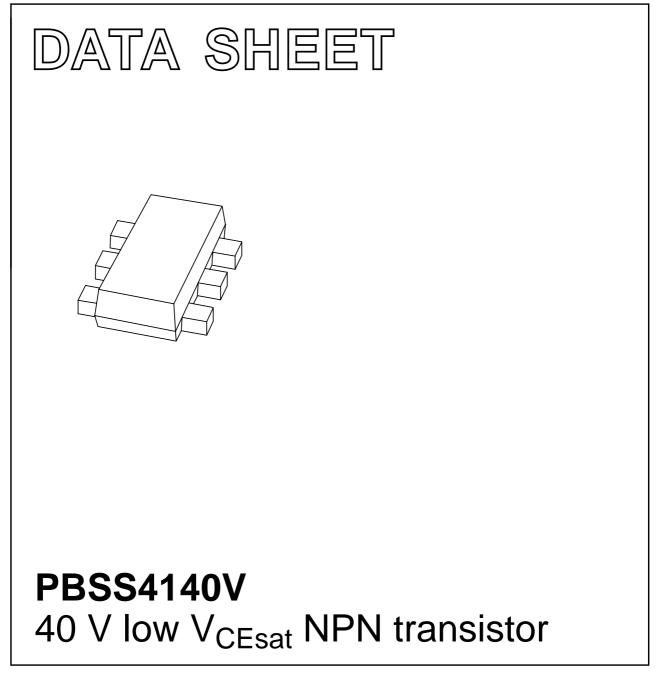
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 Nov 05 2002 Jun 20



PBSS4140V

40 V low V_{CEsat} NPN transistor

FEATURES

- 300 mW total power dissipation
- Very small 1.6 mm x 1.2 mm x 0.55 mm ultra thin package
- Improved thermal behaviour due to flat leads
- Excellent coplanarity due to straight leads
- Low collector-emitter saturation voltage
- High current capabilities
- Reduced required PCB area.

APPLICATIONS

- General purpose switching and muting
- LCD backlighting
- Supply line switching circuits
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

DESCRIPTION

NPN low $V_{\mbox{CEsat}}$ transistor with high current capability in a SOT666 plastic package. PNP complement: PBSS5140V.

MARKING

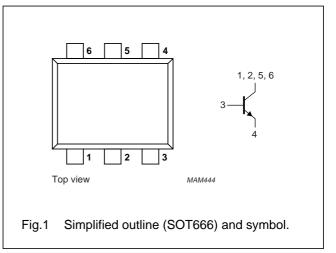
TYPE NUMBER	MARKING CODE			
PBSS4140V	22			

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT	
V _{CEO}	collector-emitter voltage	40	V	
I _C	collector current (DC)	1	А	
I _{CRP}	peak collector current	2	А	
R _{CEsat}	equivalent on-resistance <190		mΩ	

PINNING

PIN	DESCRIPTION	
1	collector	
2	collector	
3	base	
4	emitter	
5	collector	
6	collector	



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	40	V
V _{CEO}	collector-emitter voltage	open base	-	40	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current (DC)		-	1	А
I _{CM}	peak collector current		-	3	А
I _{CRP}	repetitive peak collector current	note 1	-	2	А
I _B	base current (DC)		-	300	mA
I _{BM}	peak base current		-	1	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C; note 2$	-	300	mW
		$T_{amb} \le 25 \ ^{\circ}C; \text{ note } 3$	-	500	mW
		$T_{amb} \le 25 \ ^{\circ}C$; notes 1 and 2	-	1.2	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Operated under pulsed conditions: $t_p \leq 30$ ms; $\delta \leq 0.2.$
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 3. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	410	K/W
		note 2	215	K/W
		notes 1 and 3	110	K/W

Notes

- 1. Device mounted on a printed circuit board; single sided copper; tinplated; standard footprint.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 3. Operated under pulsed conditions: $t_p \leq 30$ ms; $\delta \leq 0.2.$

Soldering

The only recommended soldering method is reflow soldering.

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CHARACTERISTICS

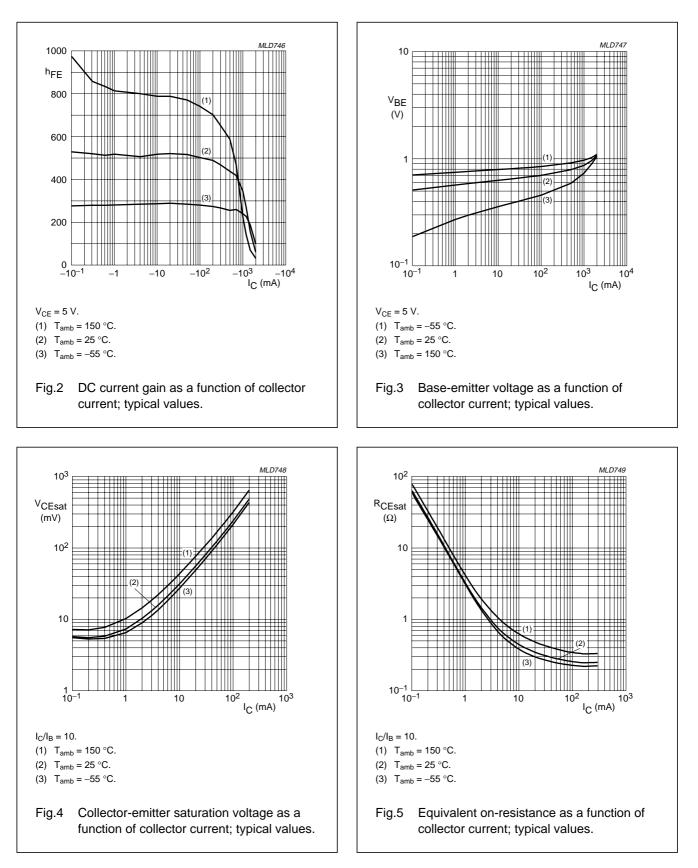
 T_{amb} = 25 °C unless otherwise specified.

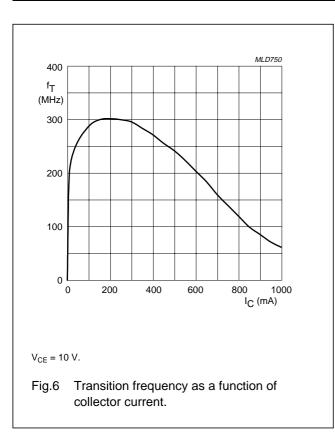
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = 40 \text{ V}; \text{ I}_{E} = 0$	-	-	100	nA
		$V_{CB} = 40 \text{ V}; \text{ I}_{E} = 0; \text{ T}_{amb} = 150 ^{\circ}\text{C}$	-	-	50	μA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0$	_	-	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0$	-	-	100	nA
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1 mA	300	-	-	
		V _{CE} = 5 V; I _C = 500 mA	300	-	900	
		V _{CE} = 5 V; I _C = 1 A	200	-	_	
		V _{CE} = 5 V; I _C = 2 A; note 1	75	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 1 mA	-	50	80	mV
		I _C = 500 mA; I _B = 50 mA	-	70	110	mV
		I _C = 1 A; I _B = 100 mA; note 1	_	150	190	mV
		$I_{\rm C} = 2 \text{ A}; I_{\rm B} = 200 \text{ mA}; \text{ note } 1$	-	320	440	mV
R _{CEsat}	equivalent on-resistance	I _C = 1 A; I _B = 100 mA; note 1	-	150	<190	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	_	-	1.2	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 5 V; I _C = 1 A	-	-	1.1	V
f _T	transition frequency	I _C = 50 mA; V _{CE} = 10 V; f = 100 MHz	150	-	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	-	10	pF

Note

1. Pulse test: $t_p \leq 300 \ \mu s; \ \delta \leq 0.02.$

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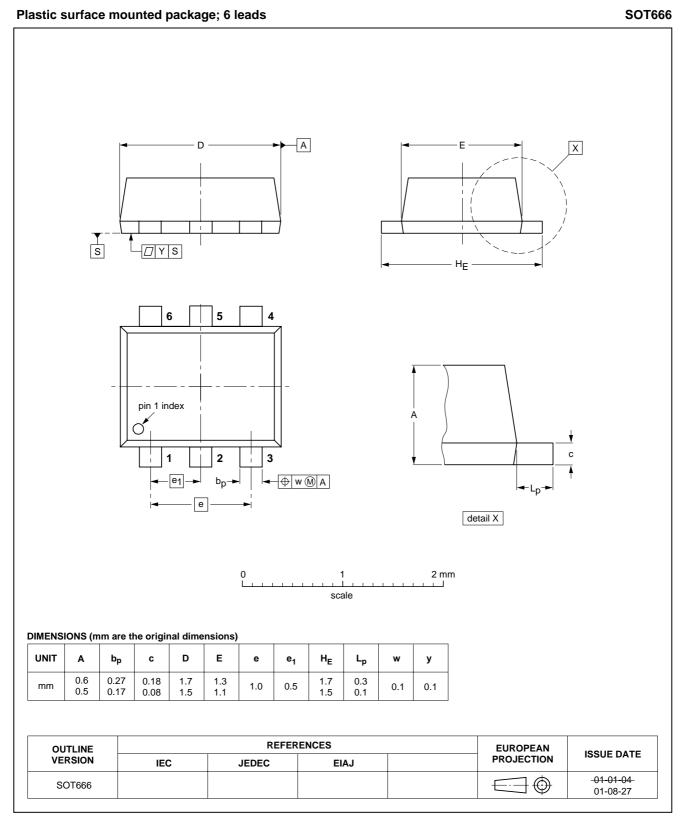


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PACKAGE OUTLINE



PBSS4140V

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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NOTES

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Contact information

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